



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Is an application of

: **Confirmation No. 6334**

Koji MISHIMA et al.

: Attorney Docket No. 2003\_1305

Serial No. 10/660,483

: Group Art Unit 1742

Filed September 12, 2003

: Examiner William T. Leader

METHOD AND APPARATUS FOR PLATING  
SUBSTRATE WITH COPPER

: **Mail Stop: RCE**

**PETITION FOR EXTENSION OF TIME**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEES FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975

Sir:

A first month extension having been previously obtained, Petition is hereby made for a second and third month extension of time to respond to the communication of July 12, 2005.

The fee of \$900.00 is

(X) submitted herewith.

() to be charged to Deposit Account No. 23-0975. A duplicate copy of this Petition is enclosed.

() Small entity status of this application is established by a Small Entity Status Assertion which

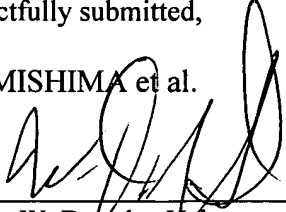
() is enclosed.

() has been previously submitted.

Respectfully submitted,

Koji MISHIMA et al.

By

  
W. Douglas Hahn  
Registration No. 44,142  
Attorney for Applicants

12/30/2005 SZEWDIE1 00000059 10660483

02 FC:1253

900.00 0P

WDH/ck

Washington, D.C. 20006-1021

Telephone (202) 721-8200

Facsimile (202) 721-8250

December 29, 2005